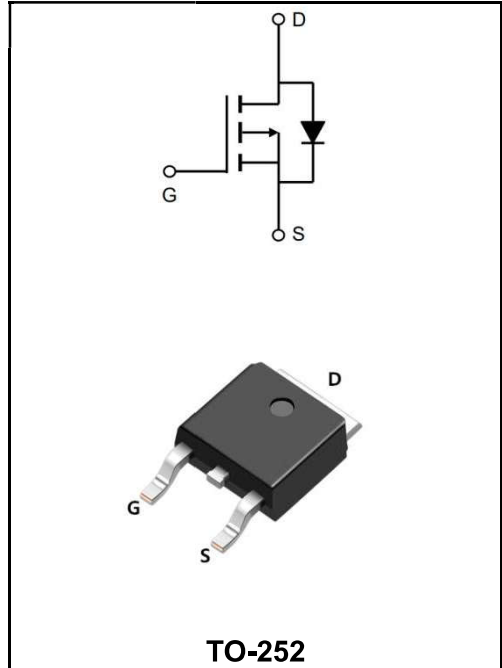


**-100V P-CHANNEL ENHANCEMENT MODE MOSFET**

**MAIN CHARACTERISTICS**

<b>I<sub>D</sub></b>	-30A
<b>V<sub>DSS</sub></b>	-100V
<b>R<sub>DS(on)-typ(@V<sub>GS</sub>=-10V)</sub></b>	< 95mΩ ( <b>Type:68 mΩ</b> )



**Application**

- ◆Brushless motor
- ◆Load switch
- ◆Uninterruptible power supply

**Product Specification Classification**

Part Number	Package	Marking	Pack
YFW30P10AD	TO-252	YFW 30P10AD XXXXX	2500PCS/Tape

**Maximum Ratings at T<sub>c</sub>=25°C unless otherwise specified**

Characteristics	Symbols	Value	Units
Drain-Source Voltage	<b>V<sub>DS</sub></b>	-100	<b>V</b>
Gate - Source Voltage	<b>V<sub>GS</sub></b>	±20	<b>V</b>
Continuous Drain Current, V <sub>GS</sub> @ -10V <sup>1</sup> @T <sub>C</sub> =25°C	<b>I<sub>D</sub></b>	-30	<b>A</b>
Continuous Drain Current, V <sub>GS</sub> @ -10V <sup>1</sup> @T <sub>C</sub> =100°C	<b>I<sub>D</sub></b>	-18	<b>A</b>
Pulsed Drain Current <sup>2</sup>	<b>I<sub>DM</sub></b>	-90	<b>A</b>
Single Pulse Avalanche Energy <sup>3</sup>	<b>E<sub>AS</sub></b>	157.2	<b>mJ</b>
Avalanche Current	<b>I<sub>AS</sub></b>	-19	<b>A</b>
Total Power Dissipation <sup>4</sup> @T <sub>C</sub> =25°C	<b>P<sub>D</sub></b>	280	<b>W</b>
Storage Temperature Range	<b>T<sub>STG</sub></b>	-55 to +150	<b>°C</b>
Operating Junction Temperature Range	<b>T<sub>J</sub></b>	-55 to +150	<b>°C</b>
Thermal Resistance Junction-Ambient <sup>1</sup>	<b>R<sub>θJA</sub></b>	62.5	<b>°C/W</b>
Thermal Resistance Junction to Case <sup>1</sup>	<b>R<sub>θJC</sub></b>	2.3	<b>°C/W</b>

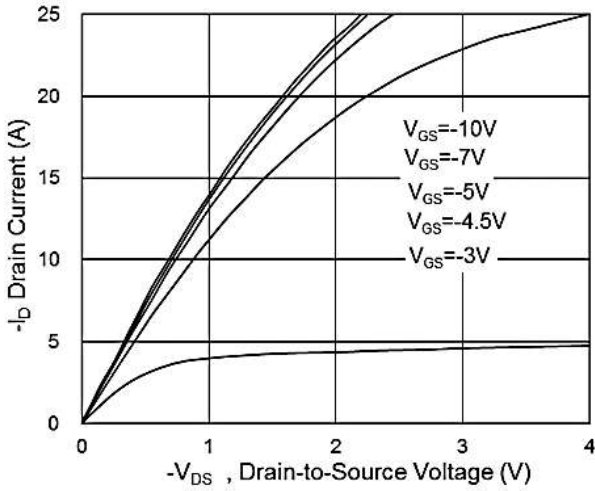
**Maximum Ratings at Tc=25°C unless otherwise specified**

Characteristics	Test Condition	Symbols	Min	Typ	Max	Units
Drain-Source Breakdown Voltage	$V_{GS}=0V, I_D=-250\mu A$	$BV_{DSS}$	-100	-	-	V
Static Drain-Source On-Resistance <sup>2</sup>	$V_{GS}=-10V, I_D=-10A$	$R_{DS(ON)}$	-	68	95	mΩ
	$V_{GS}=-4.5V, I_D=-8A$		-	78	110	
Gate -Threshold Voltage	$V_{DS}=V_{GS}, I_D=-250\mu A$	$V_{GS(th)}$	-1.2	-1.7	-2.5	V
Drain-Source Leakage Current	$V_{DS}=-100V, V_{GS}=0V, T_J=25^\circ C$	$I_{DSS}$	-	-	1	μA
Gate -Source Leakage Current	$V_{GS}=\pm 20V, V_{DS}=0V$	$I_{GSS}$	-	-	±100	nA
Forward Transconductance	$V_{DS}=-10V, I_D=-10A$	$g_{fs}$	-	24	-	S
Total Gate Charge	$V_{DS}=-50V$ $V_{GS}=-10V$ $I_D=-20A$	$Q_g$	-	44.5	-	nC
Gate-Source Charge		$Q_{gs}$	-	9.13	-	
Gate-Drain Charge		$Q_{gd}$	-	5.93	-	
Turn-on delay time	$V_{DD}=-50V$ $V_{GS}=-10V$ $I_D=-10A$ $R_G=3.3$	$t_{d(on)}$	-	12	-	ns
Rise Time		$T_r$	-	27.4	-	
Turn-Off Delay Time		$t_{d(OFF)}$	-	79	-	
Fall Time		$t_f$	-	53.6	-	
Input Capacitance	$V_{DS}=-20V$ $V_{GS}=0V$ $f=1MHz$	$C_{iss}$	-	3029	-	pF
Output Capacitance		$C_{oss}$	-	129	-	
Reverse Transfer Capacitance		$C_{rss}$	-	76	-	
Continuous Source Current <sup>1,5</sup>	$V_G=V_D=0V, \text{Force Current}$	$I_S$	-	-	-30	A
Diode Forward Voltage <sup>2</sup>	$V_{GS}=0V, I_S=-1A, T_J=25^\circ C$	$V_{SD}$	-	-	-1.2	V
Reverse Recovery Time	$I_F=-8A, dI/dt=100A/\mu s, T_J=25^\circ C$	$t_{rr}$	-	38.7	-	ns
Reverse Recovery Charge		$Q_{rr}$	-	22.4	-	nC

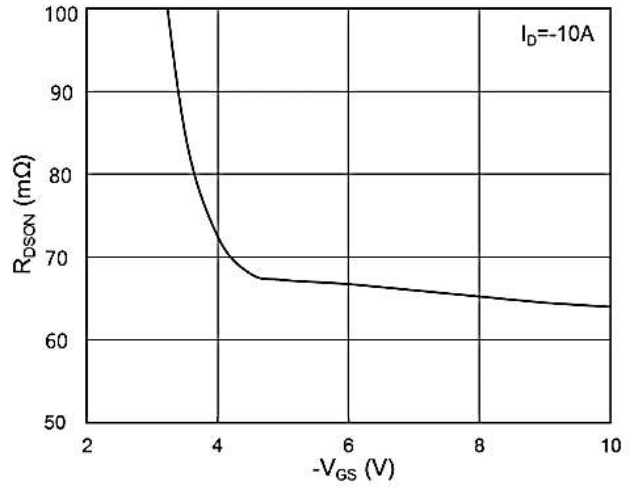
Note :

- 1、 The data tested by surface mounted on a 1 inch 2 FR-4 board with 2OZ copper.
- 2、 The data tested by pulsed , pulse width  $\leq 300\mu s$  , duty cycle  $\leq 2\%$
- 3、 The EAS data shows Max. rating . The test condition is  $V_{DD}=-72V, V_{GS}=-10V, L=0.1mH, I_{AS}=-19A$
- 4、 The power dissipation is limited by 150°C junction temperature
- 5、 The data is theoretically the same as I D and I DM , in real applications , should be limited by total power dissipation.

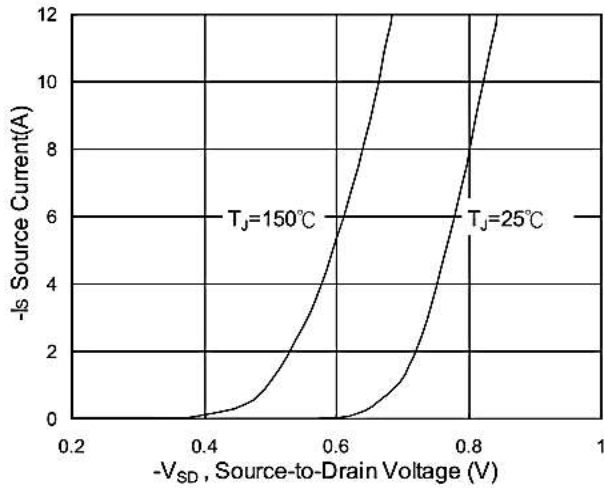
**Ratings and Characteristic Curves**



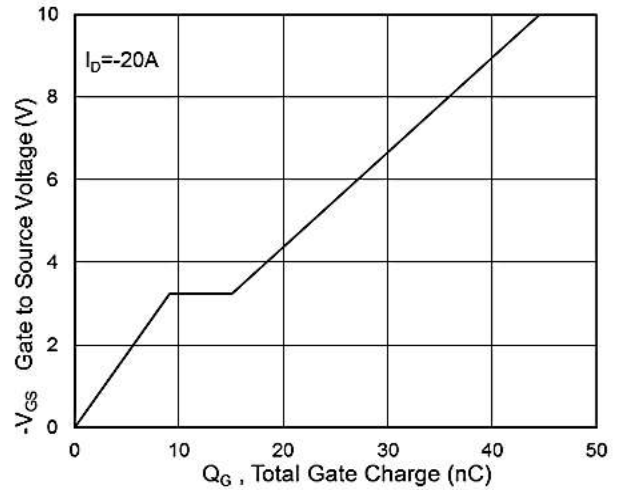
**Fig.1 Typical Output Characteristics**



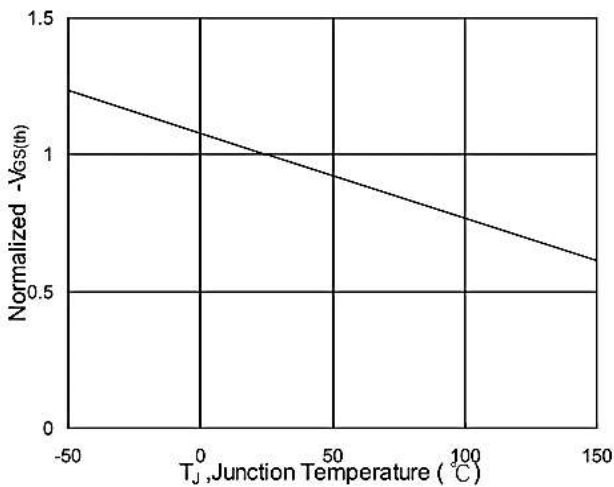
**Fig.2 On-Resistance vs G-S Voltage**



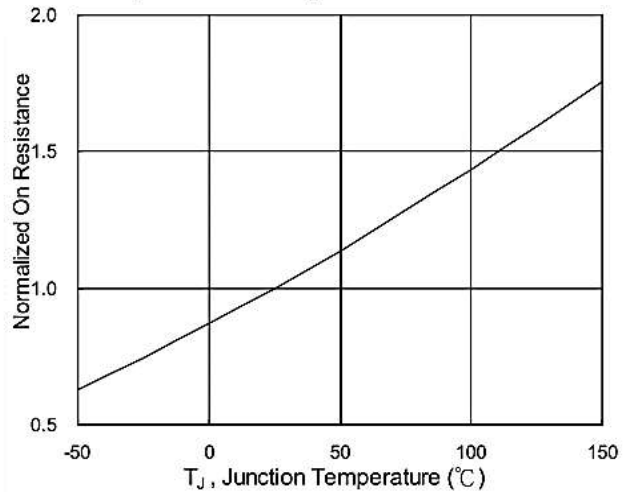
**Fig.3 Typical S-D Diode Forward Voltage**



**Fig.4 Gate-Charge Characteristics**



**Fig.5 Normalized  $V_{GS(th)}$  vs  $T_J$**



**Fig.6 Normalized  $R_{DS(on)}$  vs  $T_J$**

Ratings and Characteristic Curves

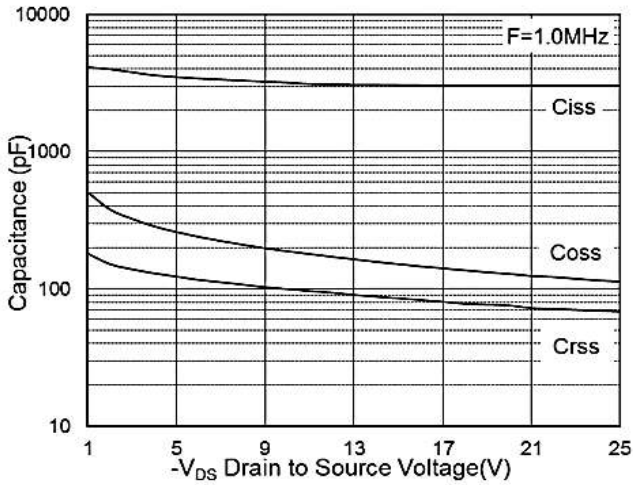


Fig.7 Capacitance

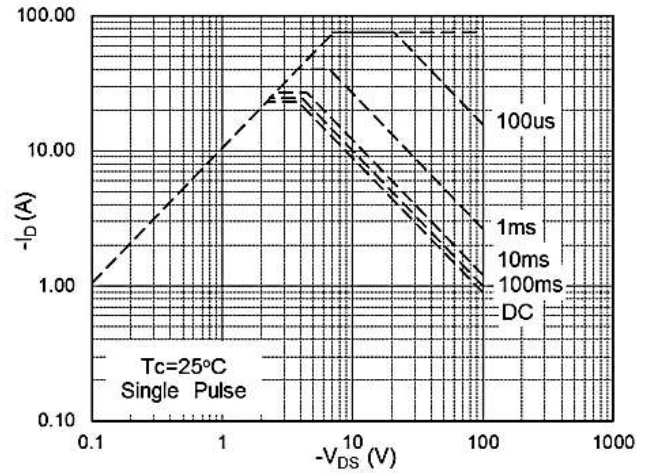


Fig.8 Safe Operating Area

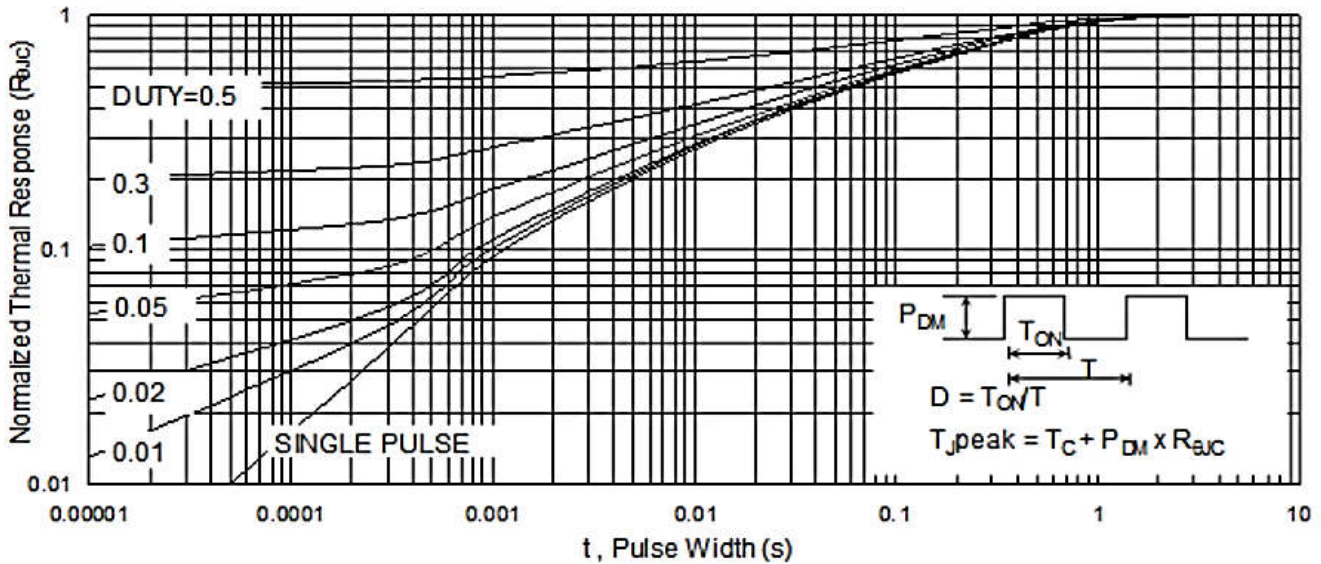


Fig.9 Normalized Maximum Transient Thermal Impedance

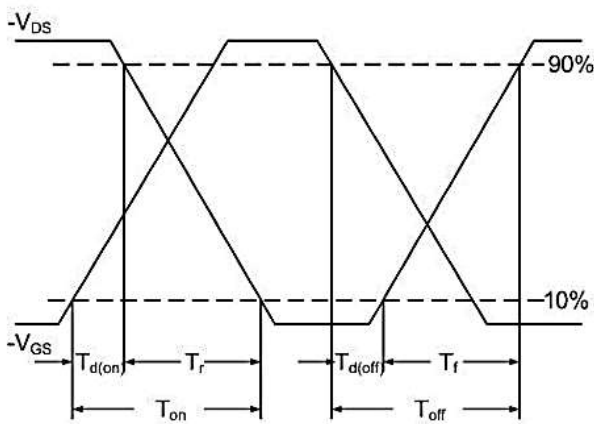


Fig.10 Switching Time Waveform

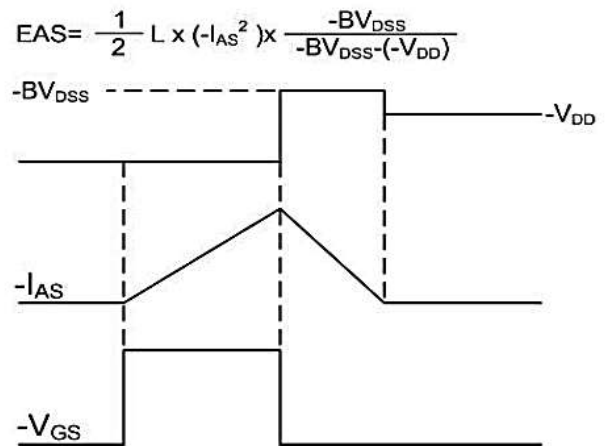


Fig.11 Unclamped Inductive Waveform

Package Outline Dimensions Millimeters

TO-252

Dim.	Min.	Typ.	Max.
A	2.10	-	2.50
A2	0	-	0.10
B	0.66	-	0.86
B2	5.18	-	5.48
C	0.40	-	0.60
C2	0.44	-	0.58
D	5.90	-	6.30
D1	5.30REF		
E	6.40	-	6.80
E1	4.63	-	-
G	4.47	-	4.67
H	9.50	-	10.70
L	1.09	-	1.21
L2	1.35	-	1.65
V1	-	7°	-
V2	0°	-	6°
All Dimensions in millimeter			

